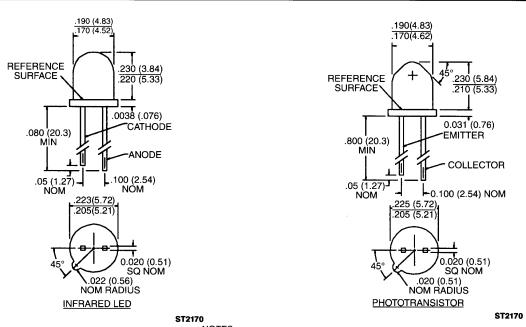


## PLASTIC TO-46/TO-18 PAIR

# **QPD5223**

## **PACKAGE DIMENSIONS**



# NOTES:

- DIMENSIONS ARE IN INCHES (mm).
   TOLERANCE IS ± .010 (.25)
   UNLESS OTHERWISE SPECIFIED.

# **DESCRIPTION**

The QPD5223 consists of an 880 nm AlGaAs LED and a silicon phototransistor mounted in plastic TO-46 (LED) and TO-18 (sensor) packages.

### **FEATURE**

- Steel lead frames for improved reliability in solder mounting.
- Good optical-to-mechanical alignment.
- Narrow emission/reception angle.
- Black plastic body allows easy recognition of sensor.



# PLASTIC TO-46/TO-18 PAIR

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C Unless Otherwise Specified)					
Storage Temperature Operating Temperature Soldering: Lead Temperature (Iron) Lead Temperature (Flow)					
INPUT DIODE Continuous Forward Current Reverse Voltage Power Dissipation					
OUTPUT TRANSISTOR Collector-Emitter Voltage Emitter-Collector Voltage Power Dissipation	30 Volts				

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
INPUT DIODE						
Forward Voltage	$V_{\scriptscriptstyle F}$	_		1.70	٧	$I_F = 20 \text{ mA}$
Reverse Leakage Current	I <sub>R</sub>	_		100	μΑ	V <sub>R</sub> = 5.0 V
OUTPUT TRANSISTOR					***************************************	
Collector-Emitter Breakdown	$BV_ceo$	30			٧	$I_F = 1.0 \text{ mA}, Ee = 0$
Collector-Emitter Leakage	I <sub>CEO</sub>	_		100	nA	V <sub>CE</sub> = 10.0 V, Ee = 0
COUPLED						- Wears
On-State Collector Current						
QPD5223	I <sub>C(ON)</sub>	7.5		_	mA	$I_F = 20 \text{mA}, V_{CC} = 5.0 \text{V}, D$

# NOTES

- Derate power dissipation linearly 2.67 mW/°C above 25°C for LED and 1.33 mW/°C for the sensor.
   RMA flux is recommended.
   Soldering iron tip 1/6" (1.6mm) minimum from case.
   D is the distance from lens tip to lens tip.
   As long as leads are not under any stress or spring tension.



### PLASTIC TO-46/TO-18 PAIR

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